# OSRAM LZ1-00UVH0 Datasheet

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# LED ENGIN LuxiGen®



Industry's most robust high power ceramic package with glass lens for high performance over life.





## **Applications**

- Agriculture & Horticulture
- Appliances & Tools
- Entertainment

- Material Processing
- Medical Lighting

#### **Features**

- Package: Ceramic package with integrated glass lens
- Chip technology: UX:3
- Typ. Radiation: 80°
- Color:  $\lambda_{peak}$  = 367 nm (• ultraviolet (UV-A))



# Ordering Information

Туре	Total radiant flux <sup>1)</sup> Ι <sub>F</sub> = 700 mA Φ <sub>E</sub>	Ordering Code
LZ1-00UVH0-0000	1100 1760 mW	Q65113A4174



# **Maximum Ratings**

Parameter	Symbol		Values
Operating Temperature	T <sub>op</sub>	min.	-30 °C
	σp	max.	85 °C
Storage Temperature	T <sub>stg</sub>	min.	-40 °C
	Jug	max.	125 °C
Junction Temperature <sup>2)</sup>	T <sub>j</sub>	max.	90 °C
Forward Current <sup>2)</sup>	I <sub>F</sub>	max.	900 mA
Forward Current pulsed t $\leq$ 10 ms; D $\leq$ 0.1 ; T <sub>c</sub> = 25 °C	I <sub>F pulse</sub>	max.	1000 mA
ESD withstand voltage acc. ANSI/ESDA/JEDEC JS-001 (HBM, Class 0)	$V_{ESD}$		ESD sensitive device
Reverse voltage 3)	V <sub>R</sub>		Not designed for reverse operation



## Characteristics

 $I_{_{\rm F}}$  = 700 mA;  $T_{_{\rm C}}$  = 25 °C

Parameter	Symbol		Values
Total radiant flux 4)	Φ <sub>E</sub>	typ.	1390 mW
Peak Wavelength <sup>5)</sup>	$\lambda_{peak}$	min.	365 nm
I <sub>E</sub> = 700 mA	peak	typ.	367 nm
		max.	370 nm
Viewing angle at 50% $I_v$	2φ	typ.	75 °
Forward Voltage 6)4)	V <sub>F</sub>	min.	3.5 V
l <sub>e</sub> = 700 mA	, i	typ.	3.8 V
		max.	4.5 V
Reverse current <sup>3)</sup>	I <sub>R</sub>		Not designed
	K		for reverse
			operation
Electrical thermal resistance junction/case	R <sub>thJC elec.</sub>	typ.	2.0 K / W



# **Brightness Groups**

Group Total radiant flux <sup>1)</sup> $I_F = 700 \text{ mA}$		Total radiant flux <sup>1)</sup> I <sub>F</sub> = 700 mA	
	min. Ф <sub>Е</sub>	max. Φ <sub>ε</sub>	
M1	1100 mW	1375 mW	
N1	1375 mW	1760 mW	

# Wavelength Groups

Group	Peak Wavelength <sup>5)</sup>	Peak Wavelength <sup>5)</sup>
	l <sub>F</sub> = 700 mA min.	l <sub>F</sub> = 700 mA max.
	λ <sub>peak</sub>	$\lambda_{peak}$
UO	365 nm	370 nm

#### **Group Name on Label** \_

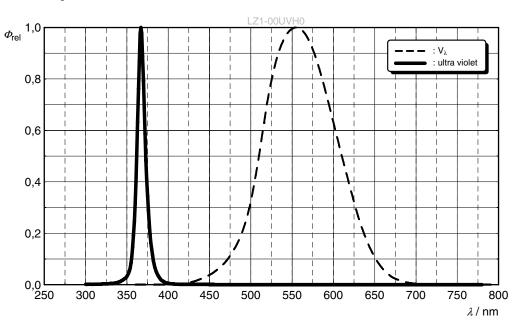
.

Example: M1-U0 Brightness	Wavelength
M1	UO



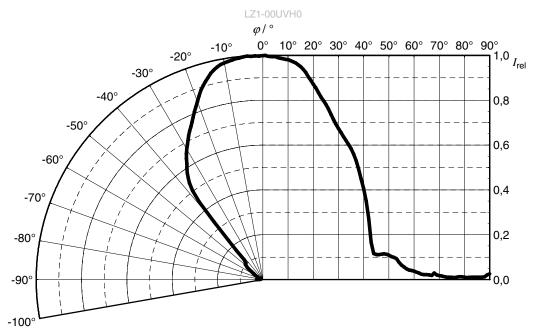
#### **Relative Spectral Emission**<sup>4)</sup>

 $\Phi_{_{rel}}$  = f ( $\lambda$ ); I<sub>F</sub> = 700 mA; T<sub>C</sub> = 25 °C



#### **Radiation Characteristics**<sup>4)</sup>

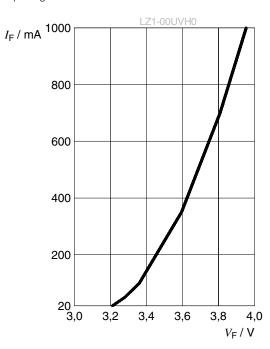
 $I_{rel} = f(\phi); T_{c} = 25 \ ^{\circ}C$ 





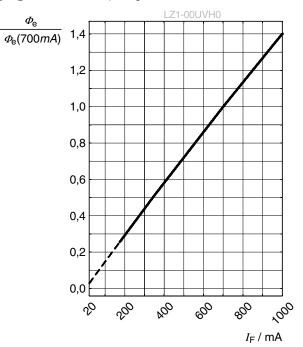
#### Forward current <sup>4)</sup>

 $I_{_{\rm F}} = f(V_{_{\rm F}}); T_{_{\rm C}} = 25 \ ^{\circ}{\rm C}$ 

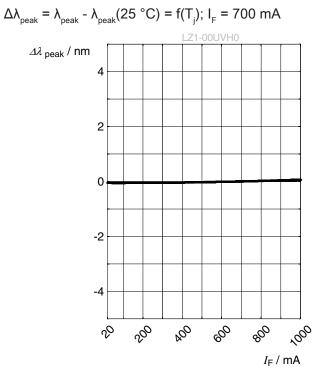


#### Relative Radiant Power<sup>4), 7)</sup>

 $\Phi_{\rm E}/\Phi_{\rm E}(700 \text{ mA}) = f(I_{\rm F}); T_{\rm C} = 25 \text{ °C}$ 

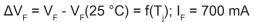


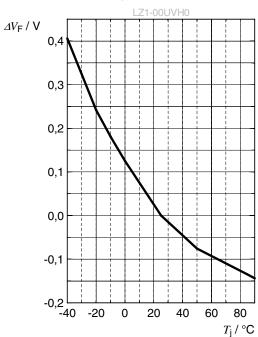
## Peak Wavelength <sup>4)</sup>





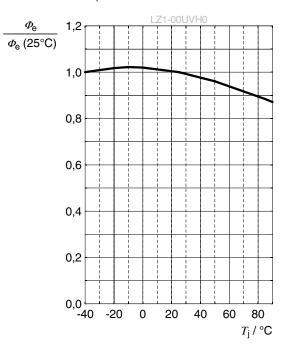
## Forward Voltage <sup>4)</sup>





#### **Relative Radiant Power**<sup>4)</sup>

 $\Phi_{_{\rm E}}/\Phi_{_{\rm E}}(25 \ ^{\circ}{\rm C}) = f(T_{_{\rm I}}); I_{_{\rm F}} = 700 \ {\rm mA}$ 



## Peak Wavelength 4)

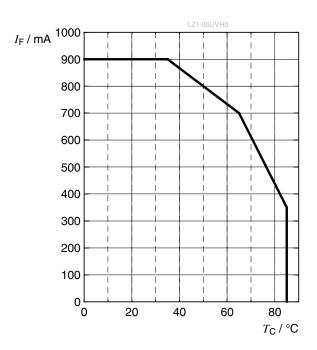
LZ1-00UVH0  $\varDelta\lambda_{peak}$  / nm <sup>10</sup> 8 6 4 2 0 -2 -4 -6 -8 -40 -20 20 80 0 40 60  $T_j / °C$ 

 $\Delta \lambda_{_{peak}} = \lambda_{_{peak}} - \lambda_{_{peak}}(25 \ ^{\circ}C) = f(T_{_j}); \ I_{_F} = 700 \ mA$ 



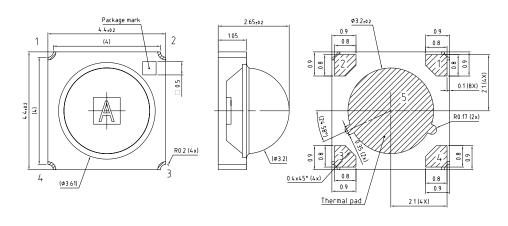
# Max. Permissible Forward Current <sup>8)</sup>

 $I_F = f(T)$ 





# Dimensional Drawing <sup>9)</sup>



General tolerance ±0.1 Pad finish Gold

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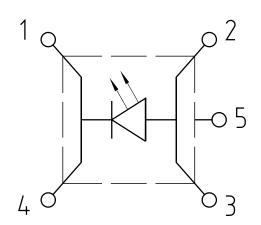
## **Further Information:**

Approximate Weight: 93.9 mg



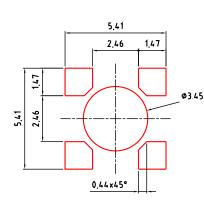
# **Electrical Internal Circuit**

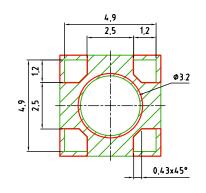
Pin Out		
Pad	Function	
1	Cathode	
2	Anode	
3	Anode	
4	Cathode	
5	Thermal	



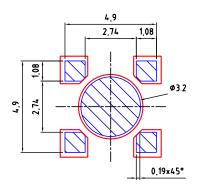


#### **Recommended Solder Pad**<sup>9)</sup>

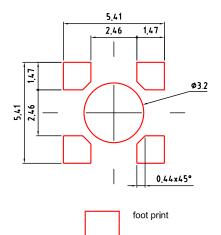


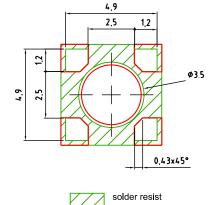


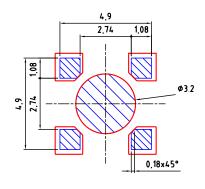
Non-pedestal MCPCB Design



Pedestal MCPCB Design



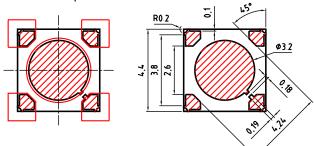






solder stencil recommended stencil thickness 200µm

Component Location on Pad



E062.3010.296-01

1. For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.

2. Package not suitable for ultra sonic cleaning.

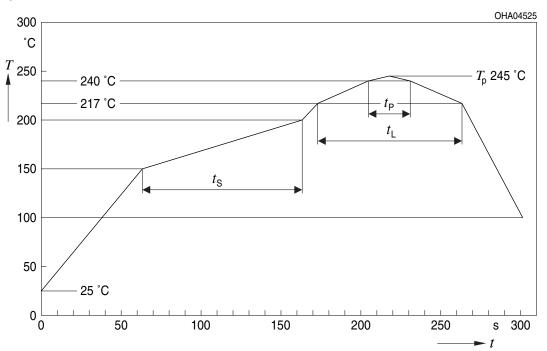
3. Pedestal MCPCB allows the emitter thermal slug to be soldered directly to the metal core of the MCPCB. Such MCPCB eliminate the high thermal resistance dielectric layer that standard MCPCB technologies use in between the emitter thermal slug and the metal core of the MCPCB, thus lowering the overall system thermal resistance.

4. X-ray sample monitoring for solder voids underneath the emitter thermal slug is recommended. The total area covered by solder voids should be less than 20% of the total emitter thermal slug area. Excessive solder voids will increase the emitter to MCPCB thermal resistance and may lead to higher failure rates due to thermal over stress.



## **Reflow Soldering Profile**





Profile Feature	Symbol Pb-Free (SnAgCu) Assembly			Unit	
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t <sub>s</sub> T <sub>Smin</sub> to T <sub>Smax</sub>	t <sub>s</sub>	60	100	120	S
Ramp-up rate to peak <sup>*)</sup> $T_{smax}$ to $T_{P}$			2	3	K/s
Liquidus temperature	TL		217		°C
Time above liquidus temperature	t <sub>L</sub>		80	100	S
Peak temperature	Τ <sub>Ρ</sub>		245	250	°C
Time within 5 °C of the specified peak temperature $T_{p}$ - 5 K	t <sub>P</sub>	10	20	30	S
Ramp-down rate* T <sub>P</sub> to 100 °C			3	4	K/s
Time 25 °C to T <sub>P</sub>				480	S

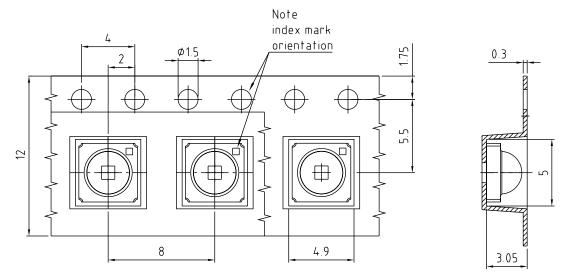
All temperatures refer to the center of the package, measured on the top of the component

 $^{\ast}$  slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

#### LZ1-00UVH0 DATASHEET



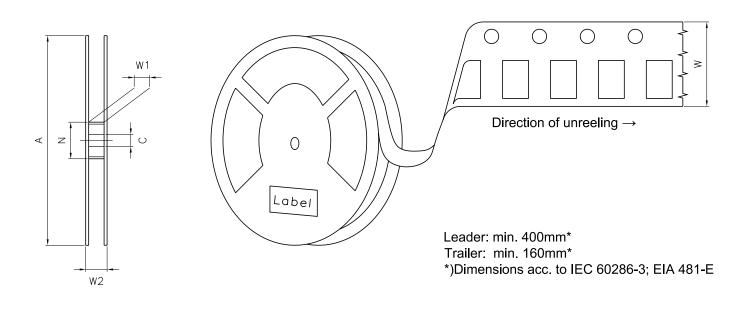
# Taping <sup>9)</sup>



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## Tape and Reel <sup>10)</sup>

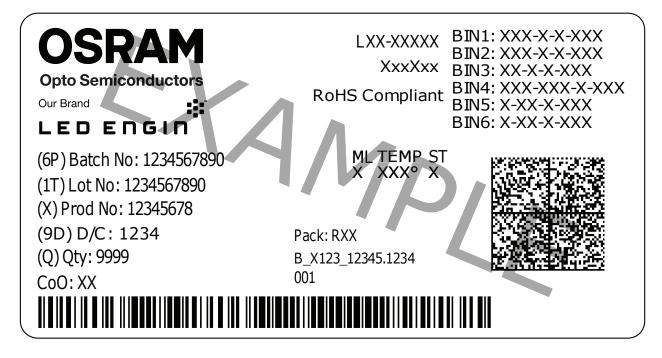


## **Reel Dimensions**

А	W	N <sub>min</sub>	W <sub>1</sub>	$W_{2 \max}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	500



## Barcode-Product-Label (BPL)



#### LZ1-00UVH0 DATASHEET



#### Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **high risk (exposure time less then 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

Tapes and reels are shipped in airtight bags in order to reduce the onset of silver tarnish. We recommend bags only be opened when ready to use emitters. Partially used reels or trays should be stored in airtight bags or in storage purged with nitrogen.

Based on very short life cycle times in chip technology this component is subject to frequent adaption to the latest chip technology.

Changes to the content of this datasheet may occur without further notification. JEDEC 46C constitutes the guideline of the change management for the device specified in this document.

For further application related information please visit https://ams-osram.com/support/application-notes



#### Disclaimer

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

#### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



#### Glossary

- <sup>1)</sup> **Brightness:** Brightness groups are tested at a current pulse duration of 10 ms and a tolerance of  $\pm 10$  %.
- <sup>2)</sup> **Operating Conditions:** Operating conditions according DC-derating (Max. Permissible Forward Current)
- <sup>3)</sup> **Reverse Operation:** Not designed for reverse operation. Continuous reverse operation can cause migration and damage of the device.
- <sup>4)</sup> Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- <sup>5)</sup> **Peak Wavelength:** Wavelengths are tested at a current pulse duration of 10 ms and a tolerance of ±2 nm.
- <sup>6)</sup> Forward Voltage: Forward voltages are tested at a current pulse duration of 10 ms and a tolerance of ±0.1 V.
- <sup>7)</sup> **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- <sup>8)</sup> **Thermal Resistance:** Rth max is based on statistic values ( $6\sigma$ ) used for Derating.
- <sup>9)</sup> **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- <sup>10)</sup> **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



# **Revision History**

Version	Date	Change
1.0	2022-06-26	Maximum Ratings Electro - Optical Characteristics (Diagrams)
1.1	2023-02-03	Maximum Ratings Electro - Optical Characteristics (Diagrams) Applications Characteristics Derating (Diagrams) Product Image
1.2	2023-12-07	Dimensional Drawing



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